

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.usplo.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/659,108	09/09/2003	Gerald H. Negley	5308-311	4336
7:	590 03/02/2005		EXAM	INER
Mitchell S. Bigel			LE, THAO X	
Myers Bigel Sibley & Sajovec, P.A. P.O. Box 37428			ART UNIT	PAPER NUMBER
Raleigh, NC 27627			2814	lier .
		DATE MAILED: 03/02/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

		<u> </u>			
	Application No.	Applicant(sŷ)			
	10/659,108	NEGLEY ET AL.			
Office Action Summary	Examiner	Art Unit			
	Thao X. Le	2814			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period or - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time y within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
1) Responsive to communication(s) filed on 18 Ja	anuary 2005.				
2a)⊠ This action is FINAL . 2b)☐ This	•				
,—	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims					
4) Claim(s) 1,3-7 and 9-20 is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 5) Claim(s) is/are allowed. 6) Claim(s) 1,3-7 and 9-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) acc Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Example 11.	epted or b) objected to by the for drawing(s) be held in abeyance. See tion is required if the drawing(s) is objected to by the formula in the drawing(s) is objected to by the formula in the drawing(s) is objected to by the formula in the formula	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
Attachment(s)					
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date <u>01/18/05</u>. 	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:				

DETAILED ACTION

1. Claims 2 and 8 are canceled in the amendment dated 18 Jan. 2005.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 3. Claims 1, 3-5, 11-17 are rejected under 35 U.S.C. 102(e) as being anticipated by US 6480389 to Shie et al.

Regarding claim 1, Shie discloses a mounting substrate for a semiconductor light emitting device in fig. 1 comprising: a solid aluminum block 10, column 2 line 61, including a cavity (concave portion) in a face thereof that is configured for mounting a semiconductor light emitting device (LED) 20 therein, fig. 1, and a conformal insulating coating 14 comprising aluminum oxide, column 3 line 4, on a surface of the solid aluminum black 10, fig. 1.

Regarding claim 3, Shie discloses the mounting substrate according to Claim 3 wherein the conformal insulating coating 14 comprising aluminum oxide, column 3 line 4, is in the cavity, fig. 2, the mounting substrate further comprising first and second

Page 3

Art Unit: 2814

spaced apart conductive traces 15a, column 3 line 22, on the conformal insulating coating 14 in the cavity that are configured for connection to a semiconductor light emitting device 20, fig. 1.

Regarding claims 4-5, 16-17 Shie discloses the mounting substrate according to Claim 3 wherein face is a first face and wherein the first and second spaced apart conductive traces 15a extend from the cavity to the first face, around at least one side of the aluminum block and onto a second face of the aluminum block that is opposite the first face, fig. 1-2, wherein the first and second spaced apart 15a on the conformal insulating coating 14 in the cavity comprise reflective material, column 3 line 8.

Regarding claims 11-14, Shie discloses the mounting substrate in combination with a semiconductor light emitting device 20 that is mounted in the cavity and is connected to the first and second spaced apart conductive traces 15a, fig. 1, further in combination with a lens 40, column 3 line 43, that extends across the cavity, in further combination with an encapsulant 30, column 3 line 39, between the semiconductor light emitting device 20 and the lens 40, and further combination with lens retainer (leg portion of lens 40) on the solid aluminum block 10 that is configured to hold the lens 40 across the cavity, fig. 1.

Regarding claim 15, Shie discloses a light emitting device in fig. 1 comprising: a solid aluminum block 10 including a cavity (concave portion), fig. 1, in a face thereof and a conformal aluminum oxide layer 14 on a surface thereof including on the cavity, fig. 2, first and second spaced apart conductive traces 15a on the conformal aluminum oxide layer 14 in the cavity; a semiconductor light emitting device 20, fig. 1 that is mounted in

the cavity and is connected to the first and second spaced apart conductive traces 15a, a lens 40 that extends across the cavity; and an encapsulant 30 between the semiconductor light emitting device 20 and the lens 40.

Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).
- 6. Claims 6-7, 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over US 640389 to Shie et al. in view of US 6531328 to Chen.

Regarding claims 6-7, Shie discloses the mounting substrate wherein the face is a first face

But, Shie does not discloses the mounting substrate wherein the solid metal block includes therein first and second through holes that extend from the first face to a second face of the solid metal block that is opposite the first face, the respective first and second through holes including a respective first and second conductive via therein that extends from the first face to the second face and wherein a respective one of the spaced apart conductive traces is electrically connected to a respective one of the conductive vias, wherein the first and second holes extend from the cavity to the second face.

However, However, Chen discloses the mounting substrate in fig. 18 comprising a first face (top surface) and wherein the solid substrate block 8, column 4 line 43, includes therein first and second through holes 14, column 4 line 58 that extend from the first face to a second face of the solid block 8 that is opposite the first face, the respective first and second through holes including a respective first and second conductive via therein that extends from the first face to the second face and wherein a respective one of the spaced apart conductive traces 16/17/18, column 5 lines 5-10, is electrically connected to a respective one of the conductive vias 14, fig. 18, and vias 14 extend from the cavity 11, fig. 8, to the second face. At the time the invention was made; it would have been obvious to one of ordinary skill in the art to use the conductive vias of LED packaging teaching of Chen with Shie, because it would have provided good the thermal dissipation of the LED device as taught by Chen, see abstract.

Regarding claim 10, Shie discloses a mounting substrate further comprising third and fourth space apart conductive traces 12/51, column 2 line 66, on the second face of the solid aluminum block, fig. 1.

But Shie does not disclose the traces are connected to a respective one of the conductive vias.

However, However, Chen discloses the mounting substrate in fig. 18 further comprising third and fourth space apart conductive traces 18/17 on the second face of the solid block a respective one of which is connected to a respective one of the conductive vias 14. At the time the invention was made; it would have been obvious to one of ordinary skill in the art to use the conductive vias of LED packaging teaching of Chen with Shie, because it would have provided good thermal dissipation of the LED device as taught by Chen, see abstract.

7. Claims 9, 18-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over US 640389 to Shie et al. and US 6531328 to Chen as applied to the above claims 1 3 and 6 and 15 and further in view of US 2004/0222433 to Mazzochette at el.

Regarding claims 9 and 18, ass discussed in the above claims 1, 3, 6 and 15, Shie and Chen disclose all the limitation of claims 9 and 18, except the through holes including the conformal insulating coating thereon.

But Mazzochette discloses a mounting substrate in fig. 4 comprises a metal base 11, a LED 10, a spaced apart conductive wires 13 [0025], a though hole 14 [0026], and a conformal dielectric layer 12 [0029]. At the time the

invention was made; it would have been obvious to one of ordinary skill in the art to use the teaching of through holes comprises conformal dielectric layer teaching of Mazzochette with Shie and Chen's device, because it would have enhanced the heat flow by the via that the LED package can operate at a high temperature as taught by Mazzochette, see abstract.

Page 7

Regarding claim 19, Shie discloses the LED wherein the face is a first face But, Shie does not discloses the LED wherein the first and second through holes that extend from the first face to a second face.

However, However, Chen discloses the LED wherein the face is a first face

But, Shie does not discloses the LED wherein the first and second through holes that extend from the first face to a second face, fig. 18. At the time the invention was made; it would have been obvious to one of ordinary skill in the art to use the conductive vias of LED packaging teaching of Chen with Shie, because it would have provided good the thermal dissipation of the LED device as taught by Chen, see abstract.

Regarding claim 20, Shie discloses the LED further comprising third and fourth space apart conductive traces 12/51, column 2 line 66, on the second face of the solid aluminum block, fig. 1.

But Shie does not disclose the traces are connected to a respective one of the conductive vias.

However, However, Chen discloses the LED in fig. 18 further comprising third and fourth space apart conductive traces 18/17 on the second face of the

solid block a respective one of which is connected to a respective one of the conductive vias 14. At the time the invention was made; it would have been obvious to one of ordinary skill in the art to use the conductive vias of LED packaging teaching of Chen with Shie, because it would have provided good thermal dissipation of the LED device as taught by Chen, see abstract.

Page 8

Response to Arguments

8. Applicant's arguments filed on 18 Jan. 2005 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

9. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thao X. Le whose telephone number is (571) 272-1708. The examiner can normally be reached on M-F from 8:00 AM - 4:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael M. Fahmy can be reached on (571) 272 -1705. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Thao X. Le 22 Feb. 2004

> Loxig Pham T...Vay examiner